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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/813,330	03/30/2004	Jong-myeong Lee	5649-1205 5124		
20792 7	590 05/02/2005	EXAMINER			
	EL SIBLEY & SAJOVE	EVERHART, CARIDAD			
PO BOX 37425 RALEIGH, No	=		ART UNIT	PAPER NUMBER	
			2891		
			DATE MAILED: 05/02/2005		

Please find below and/or attached an Office communication concerning this application or proceeding.

		Application	on No.	Applicant(s)	$\wedge$				
		10/813,33	30	LEE ET AL.	(M)				
	Office Action Summary	Examiner		Art Unit					
• •			1. Everhart	2891					
The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply									
THE - Exte after - If the - If NC - Failt Any	ORTENED STATUTORY PERIOD FOR F MAILING DATE OF THIS COMMUNICAT nsions of time may be available under the provisions of 37 ( SIX (6) MONTHS from the mailing date of this communicat p period for reply specified above is less than thirty (30) days p period for reply is specified above, the maximum statutory tre to reply within the set or extended period for reply will, by reply received by the Office later than three months after the ed patent term adjustment. See 37 CFR 1.704(b).	TION.  CFR 1.136(a). In no evolution.  s, a reply within the state period will apply and we state the app	ent, however, may a reply be tim utory minimum of thirty (30) day: ill expire SIX (6) MONTHS from lication to become ABANDONE	nely filed s will be considered timely. the mailing date of this comr D (35 U.S.C. § 133).	nunication.				
Status									
1)⊠	Responsive to communication(s) filed on	2-9-05							
2a)⊠	This action is <b>FINAL</b> . 2b)	This action is n	on-final.						
3)□	Since this application is in condition for allowance except for formal matters, prosecution as to the ments is closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213.								
Disposit	ion of Claims								
5)⊠	· <u> </u>								
Applicat	ion Papers								
9)[	The specification is objected to by the Exa	aminer.							
10)	☐ The drawing(s) filed on is/are: a)☐ accepted or b)☐ objected to by the Examiner.								
	Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).								
11)	Replacement drawing sheet(s) including the of the oath or declaration is objected to by the oath or declaration is objected to by the oath or declaration is objected to be the oath of the oath or declaration is objected to be the oath of th	•			• •				
Priority ı	under 35 U.S.C. § 119								
12) [ a)	Acknowledgment is made of a claim for for All b) Some * c) None of:  1. Certified copies of the priority docu 2. Certified copies of the priority docu 3. Copies of the certified copies of the application from the International Elee the attached detailed Office action for	uments have bee uments have bee e priority docume Bureau (PCT Rul	n received. n received in Applicati ents have been receive e 17.2(a)).	on No ed in this National St	age				
Attachmen	t(s)	•							
	e of References Cited (PTO-892)		4) Interview Summary	(PTO-413)	•				
3) 🛛 Infori	e of Draftsperson's Patent Drawing Review (PTO-94 mation Disclosure Statement(s) (PTO-1449 or PTO/5 r No(s)/Mail Date 2-25-05		Paper No(s)/Mail Da 5) Notice of Informal P 6) Other:		52)				

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Applicant's arguments with respect to claims 1, 3, 4, 6, and 13-18 have been considered but are most in view of the new ground(s) of rejection.

Applicant has amended the claims to include the lilmitation " an oxide layer included in" after the recitation "to expose an upper surface".

The text of those sections of Title 35, U.S. Code not included in this action can be found in a prior Office action.

## Claim Rejections - 35 USC § 102

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

Claims 1, 3, 4, 6, 13, 14,17, and 18 are rejected under 35 U.S.C. 102(b as being anticipated by Tanahashi (US 6,064,084).

Tanahashi discloses the steps of removing the barrier outside of a damascene pattern(Fig. 7C shows the barrier 84 removed from the surface of layer 82), which is the same as an intaglio pattern, and the layer in which the damascene pattern is formed is an oxide layer(col. 12, lines 55-59 disclose that the interlayer insulation film in the embodiments is SiO2), while leaving the barrier inside the damascene pattern(Fig. 7C), forming a conductive layer on the damascene pattern(col. 15, lines 1-3 indicate that the further steps would follow the other embodiments, which include filling with conductor, as in col. 12, lines 25-30), and removing the conductive layer from the upper surface of the oxide layer(Fig. 4L shows conductive layer 38, and Fig. 4M shows the conductive

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layer removed from the surface of the oxide layer; since it is disclosed by Tanahashi that the embodiment in Fig. 7C would also follow these steps, the conductor would also be deposited to fill the opening in Fig. 7C and would also be removed from the surface of the oxide in Fig. 7C). In Fig. 7B and Fig. 7C it is seen that there are formed a hole and a groove at the top of the hole. The conductive layer is formed in the hole and in the groove. The bit line pattern taught by Tanahashi is polysilicon, but may be replaced by other conductor which includes a barrier layer which includes TiN(col. 12, lines 55-60). The planarization is performed using CMP(col. 14, lines 57-58). The metal fill may be aluminum(col. 9, lines 62-67 and col. 10, lines 1-3). The conductor is deposited by CVD(col. 3, lines 30-34), as the conductive film is deposited by CVD, and Tanahashi discloses that aluminum may be used instead of polysilicon

## Claim Rejections - 35 USC § 103

Claim 15 is rejected under 35 U.S.C. 103(a) as being unpatentable over Tanahashi as appied to claim 14 above further in view of Doan, et al.

Tanahashi is silent with respect to the reflow step.

Doan, et al discloses that reflow of the aluminum fill layer results in improved fill (page 199).

It would have been obvious to one of ordinary skill in the art at the time of the invention to have combined the step taught by Doan, et al with the process taught by Tanahashi in order to obtain improved fill of the damascene structure.

Claim 16 is rejected under 35 U.S.C. 103(a) as being unpatentable over Tanahashi in view of Ono, et al.

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Tanahashi is silent with respect to the conductor comprising copper, although Tanahashi discloses that other conductors can be used, as cited above.

Ono et al discloses that alloys of aluminum can be used in the fill of contact openings and one of the alloys comprises copper(page 77, next to the last paragraph).

It would have been obvious to one of ordinary skill in the art at the time of the invention to have used conductor that comprises copper in the method taught by Tanahashi in order to improve the reflow properties of the conductor layer.

## Allowable Subject Matter

Claims 2,5,7-12 are objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims.

Claims 19 and 20 are allowed.

Applicant's amendment made the new grounds of rejection necessary, therefore,

THIS ACTION IS MADE FINAL. Applicant is reminded of the extension of time

policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of

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the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Caridad M. Everhart whose telephone number is 571-272-1892. The examiner can normally be reached on Monday through Fridays 7:30-4:00.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, B. Baumeister can be reached on 571-272-1722. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

C. Everhart 4-27-2005